Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

# 2SK2750

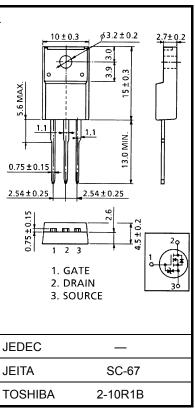
# Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain–source ON resistance : RDS (ON) =  $1.7 \Omega$  (typ.) • High forward transfer admittance :  $|Y_{fs}| = 3.0 S$  (typ.) • Low leakage current : IDSS =  $100 \mu A$  (max) (VDS = 600 V)

• Enhancement mode :  $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$ 

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteri	stics	Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	600	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	600	V	
Gate-source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC (Note 1)	I <sub>D</sub>	3.5	Α	
	Pulse (Note 1)	I <sub>DP</sub>	14	Α	
Drain power dissipatio	n (Tc = 25°C)	P <sub>D</sub>	35	W	
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	201	mJ	
Avalanche current		I <sub>AR</sub>	3.5	Α	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	3.5	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	3.57	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 28.8 mH,  $R_{G}$  = 25  $\Omega$ ,  $I_{AR}$  = 3.5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



## **Electrical Characteristics (Ta = 25°C)**

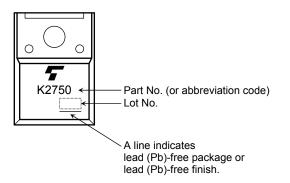
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cut-off cur	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	600	_	_	V
Gate threshold v	/oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source Ol	N resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.8 A	_	1.7	2.2	Ω
Forward transfer	r admittance	Y <sub>fs </sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.8 A	2.0	3.0	_	S
Input capacitano	e	C <sub>iss</sub>		_	800	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	6	_	pF
Output capacitance		Coss			65	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $0V$ $0V$ $0V$ $0V$ $0V$ $0V$ $0V$ $0V$	_	15	_	
	Turn-on time	t <sub>on</sub>		_	50	_	- ns
	Fall time	t <sub>f</sub>		_	15	_	
	Turn-off time	t <sub>off</sub>		_	85	_	
Total gate charg plus gate-drain)		Qg			20	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$		10	_	nC
Gate-drain ("miller") Charge		Q <sub>gd</sub>			10	_	

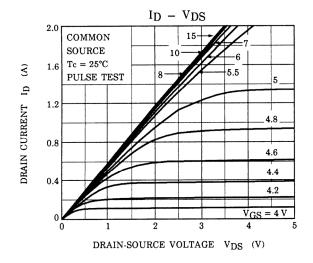
## **Source-Drain Ratings and Characteristics (Ta = 25°C)**

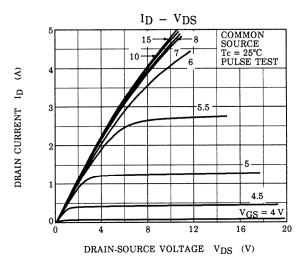
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	3	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	14	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 3.5 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 3.5 A, V <sub>GS</sub> = 0 V		1400	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dl <sub>DR</sub> / dt = 100 Å / μs	_	9	_	μC

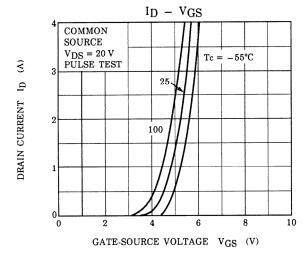
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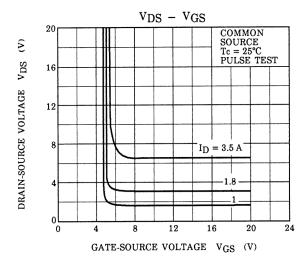
## Marking

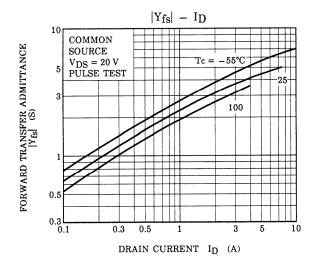


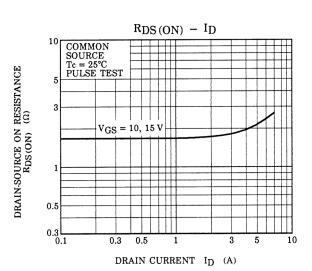


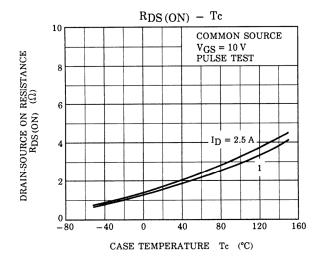


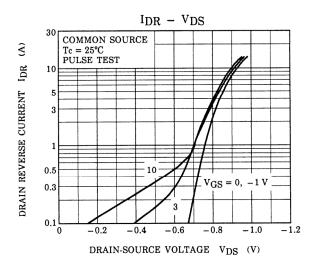


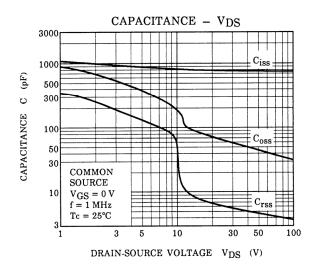


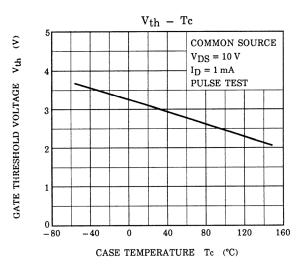


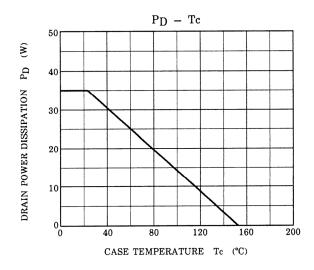


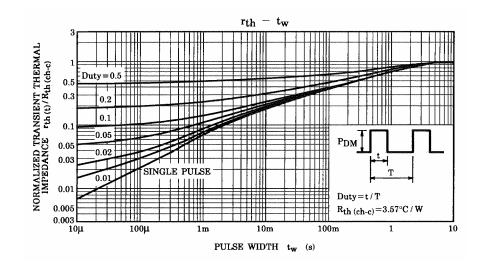


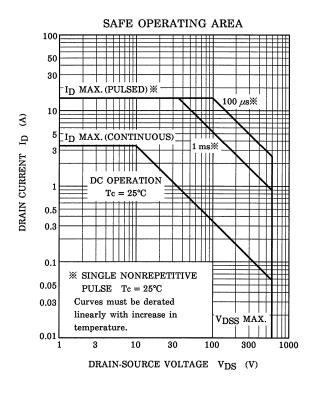


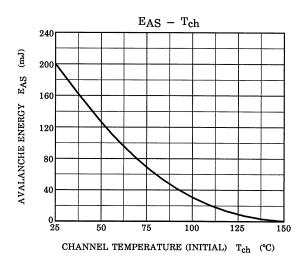


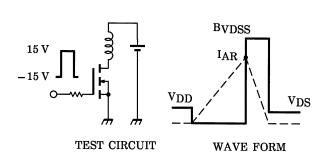












$$R_G$$
 = 25  $\Omega$   
 $V_{DD}$  = 90 V, L = 28.8 mH

$$EAS = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right)$$

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